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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/823,355	04/12/2004	Robert Martinson	NOVE100042000 4719		
22891 LAW OFFICE	7590 09/17/200 OF DELIO & PETERS	EXAMINER			
121 WHITNEY AVENUE 3RD FLLOR NEW HAVEN, CT 06510			BAND, MICHAEL A		
			ART UNIT PAPER NUM		
	,		1753	· · · · · · · · · · · · · · · · · · ·	
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			MAIL DATE	DELIVERY MODE	
			09/17/2007	PAPER .	

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)		
10/823;355	MARTINSON ET AL.		
Examiner	Art Unit		
Michael Band	1753		

A	Michael Band		1753	
The MAILING DATE of this communication appe	ars on the cover sheet	t with the c	correspondence add	ress
THE REPLY FILED 10 September 2007 FAILS TO PLACE THI	S APPLICATION IN CO	NDITION F	FOR ALLOWANCE.	
 The reply was filed after a final rejection, but prior to or on this application, applicant must timely file one of the follow places the application in condition for allowance; (2) a No (3) a Request for Continued Examination (RCE) in compli following time periods: 	ving replies: (1) an ame tic e of Appeal (with app ance with 37 CFR 1.11	ndment, aff beal fee) in	fidavit, or other evider compliance with 37 C	nce, which CFR 41.31; or
a) The period for reply expiresmonths from the mailing b) \[The period for reply expires on: (1) the mailing date of this A event, however, will the statutory period for reply expire later Examiner Note: If box 1 is checked, check either box (a) or (MONTHS OF THE FINAL REJECTION. See MPEP 706.07(dvisory Action, or (2) the d than SIX MONTHS from t b). ONLY CHECK BOX (b	he mailing d	late of the final rejection.	
Extensions of time may be obtained under 37 CFR 1.136(a). The date been filed is the date for purposes of determining period of extension CFR 1.17(a) is calculated from: (1) the expiration date of the shortened above, if checked. Any reply received by the Office later than three mo earned patent term adjustment. See 37 CFR 1.704(b). NOTICE OF APPEAL	and the corresponding ame statutory period for reply o	ount of the foriginally set	ee. The appropriate extended in the final Office action	ension fee under 37 ;aos (22)t forth in (b)
2. The Notice of Appeal was filed on A brief in comp of filing the Notice of Appeal (37 CFR 41.37(a)), or any ex Since a Notice of Appeal has been filed, any reply must b AMENDMENTS	tension thereof (37 CFF	R 41.37(e))	, to avo id dismissal d	of the appeal.
3. The proposed amendment(s) filed after a final rejection, (a) They raise new issues that would require further count (b) They raise the issue of new matter (see NOTE below	nsideration and/or searc			because
(c) They are not deemed to place the application in bet appeal; and/or	ter form for appeal by m			the issues for
(d) They present additional claims without canceling a	corresponding number of	of finally re	ejected claims.	
NOTE: (See 37 CFR 1.116 and 41.33(a)). 4. The amendments are not in compliance with 37 CFR 1.1	21 See attached Notice	a of Non-C	omnliant Amendment	(PTOL -324)
5. Applicant's reply has overcome the following rejection(s)			omphant Amenament	(1 10L-024).
6. Newly proposed or amended claim(s) would be a the non-allowable claim(s).		a separate,	timely filed amendm	ent canceling
7. Tor purposes of appeal, the proposed amendment(s): a) how the new or amended claims would be rejected is provided that the status of the claim(s) is (or will be) as follows:			vill be entered and an	explanation of
Claim(s) allowed: Claim(s) objected to: Claim(s) rejected:	·			
Claim(s) withdrawn from consideration: AFFIDAVIT OR OTHER EVIDENCE		*		
 The affidavit or other evidence filed after a final action, be because applicant failed to provide a showing of good and and was not earlier presented. See 37 CFR 1.116(e). 				
 The affidavit or other evidence filed after the date of filing entered because the affidavit or other evidence failed to o showing a good and sufficient reasons why it is necessary 	vercome <u>all</u> rejections to and was not earlier pro	inder appe esented. S	al and/or appellant fa ee 37 CFR 41.33(d)(ils to provide a 1).
10. The affidavit or other evidence is entered. An explanatio REQUEST FOR RECONSIDERATION/OTHER	n of the status of the cla	ims after e	entry is below or attac	hed.
The request for reconsideration has been considered bu See Continuation Sheet.	t does NOT place the a	pplication i	n condition for allowa	nce because:
12. ☐ Note the attached Information Disclosure Statement(s).13. ☐ Other:	PTO/SB/08) Paper No(·	s)	•	
		•	. •	

Continuation of 11 does NOT place the application in condition for allowance because:

On page 11 of the Applicant's Remarks, Applicant argues that the Chung et al depicts pedestal shielding ring [84] and lower chamber shield [48] as not cooperating unless the pedestal is in the lowered position [fig. 6A]. The Applicant respectfully notes that this cooperation when the pedestal is in a raised position is an integral part of the claimed invention. Applicant also argues that removing the wafer horizontally is neither inherent nor obvious since Chung et al makes no disclosure or suggestion for this type of removal.

The Examiner respectfully disagrees with Applicant's arguments because in the raised position [fig. 6B], the pedestal shielding ring [84] and the lower chamber shield [48] are still functioning in a cooperative manner despite not being in near contact w ith one another [fig. 6A] since the two parts are simultaneously blocking unwanted deposition particles from reaching the walls and the floor of the deposition chamber. In addition, cooperation of the shielding ring [84] and lower chamber shield [48] does not require contact, as implied by Applicant's arguments, since these two parts function simultaneously for blocking particles regardless of being in a raised or lowered position. As Applicant has stated, Chung et al does not disclose or suggest how to loa d or unload a wafer. However, therefore must exist some method to load and unload the wafer. Chung et al does not suggest this but does disclose in fig. 6A a connector pin that can remove lower chamber shield [48]. Since Chung et al does not further suggest or disclose any other method, it is either inherent or obvious to one of ordinary skill in the art to remove a wafer utilizing the removal of the connector pin and therefore the lower chamber shield. The removal of the wafer is necessary either to further process said in another chamber/system or to prepare the wafer for packaging as a final product.

ALEXA D. NECKEL

SUPERVISORY PATENT EXAMINER